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(54) SIDELINK REFERENCE SIGNAL AND MEASUREMENT REPORT SHARING

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(57)ABSTRACT

Various aspects of the present disclosure generally relate to wireless communication. In some aspects, a first user equipment (UE) may generate information indicating a reference signal and a measurement report for a first sidelink between the first UE and a second UE. The first UE may use the information for a second sidelink between the first UE and the second UE. Numerous other aspects are described.

